

Low Sensitive Pull High Res Omnipolar Hall Switch

MH278 Hall effect switch is a temperature stable, Superior high-temperature performance is made possible through a dynamic offset cancellation that utilizes chopper-stabilization.

MH278 includes the following on a single silicon chip: voltage regulator, Hall voltage generator, small-signal amplifier, chopper stabilization, Schmitt trigger, and pull up resistor integrated on chip. Advanced DMOS wafer fabrication processing is used to take advantage of low-voltage requirements, component matching, very low input-offset errors, and small component geometries.

This device requires the presence of omni-polar magnetic fields for operation.

MH278 is rated for operation between the ambient temperatures -40°C and +85°C for the E temperature range. and -40°C to +125°C for the K temperature range. The two package styles available provide magnetically optimized solutions for most applications. Package types SO is a SOT-23, a miniature low-profile surface-mount package, while package UA is a three-lead ultra-mini SIP for through-hole mounting.

The package type is in a Halogen Free version was verified by third party Lab.

Features and Benefits

- DMOS Hall IC Technology.
- Operation range from 2.5V to 26V.
- Omni polar, output switches with absolute value of North or South pole from magnet.
- High Sensitivity for reed switch replacement applications.
- Low sensitivity drift in crossing of Temp range.
- High ESD Protection, HBM $> \pm 4$ KV(min)
- Output Current limit in 100mA.
- RoHS compliant 2011/65/EU and Halogen Free

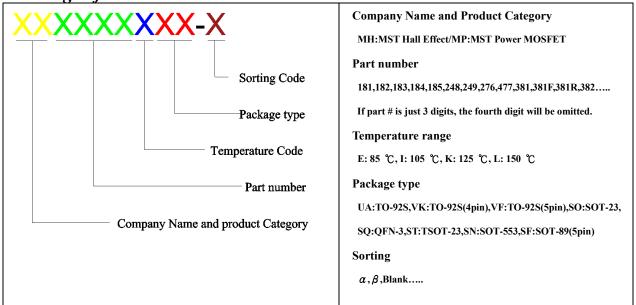
Applications

- Solid state switch.
- Limit switch.
- Current limit.
- Interrupter.
- Current sensing.
- Magnet proximity sensor for reed switch replacement.



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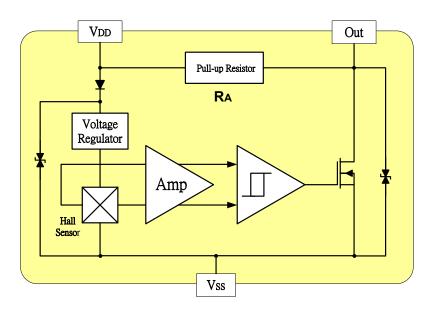
Ordering Information



Part No.	Temperature Suffix	Package Type
MH278KUA	K $(-40^{\circ}\text{C to } +125^{\circ}\text{C})$	UA (TO-92S)
MH278EUA	E (-40°C to +85°C)	UA (TO-92S)
MH278KSO	$K (-40^{\circ}C \text{ to} + 125^{\circ}C)$	SO (SOT-23)
MH278ESO	E $(-40^{\circ}\text{C to} + 85^{\circ}\text{C})$	SO (SOT-23)

KUA spec is using in industrial and automotive application. Special Hot Testing is utilized.

Functional Diagram





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Absolute Maximum Ratings At (Ta=25°C)

Characteristics			Values	Unit	
Supply voltage,(VDD)			28	V	
Output Voltage,(Vout)			28	V	
Reverse Voltage, (VDD / Vout)			-0.3/-0.3	V	
Output current, (ISINK)			25	mA	
O	"E" Class		-40 ~ +85	°C	
Operating Temperature Range	,(IA)	"K" Class	-40 ~ +125	°C	
Storage temperature Range, (<i>Ts</i>)			-55 ∼ +150	°C	
Maximum Junction Temp,(T _J)			150	°C	
Thermal Resistance	(θ_{JA}) UA/ SO		206 / 543	°C/w	
	(θsc) UA/ SO		148 / 410	°C/w	
Package Power Dissipation, (PD)			606 / 230	mW	

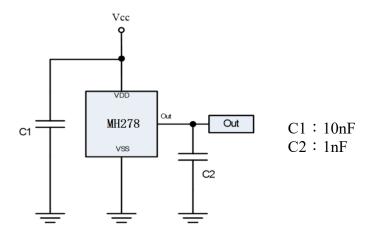
 $\textit{Note}: \textit{Do not apply reverse voltage to V_{DD} and V_{OUT} \textit{ Pin, It may be caused for Miss function or damaged device.} \\$

Electrical Specifications

DC Operating Parameters : T_A =+25°C, V_{DD} =12V

Parameters	Test Conditions	Min	Тур	Max	Units
Supply Voltage, (V_{DD})	Operating	2.5		26.0	V
Supply Current, (I_{DD})	B <b<sub>OP</b<sub>		2.5	5.0	mA
Output Saturation Voltage, (V_{DSON})	I _{OUT} =20mA, B>B _{OP}		300	500.0	mV
Output Leakage Current, (<i>I</i> _{OFF})	I_{OFF} B <b<sub>RP, $V_{OUT} = 20V$</b<sub>			10.0	uA
Output Limited Current, (I _{CO})	B>B _{OP}		100		mA
Power-On Time, (T_{PO})	Power-On			100	uS
Output Switch Time, (T_{SW})	Operating			100	uS
Output Switch Frequency, (F_{SW})	Operating	5			kHz
Output Rise Time, (T_R)	$C_L = 20pF$		0.1	0.45	uS
Output Fall Time, (T_F)	$C_L = 20pF$		6.0	10	uS
Electro-Static Discharge	HBM	4			KV
Pull-up Resistor, (RA)			10		ΚΩ
Operate Point, $B_{OPS}(B_{OPN})$	B>B _{OPS} (B <b<sub>OPN), V_{OUT} On</b<sub>	140(-250)		250(-140)	Gauss
Release Point, $B_{RPS}(B_{RPN})$	B <b<sub>RPS(B>B_{RPN}), V_{OUT} Off</b<sub>	95(-205)		205(-95)	Gauss
Hysteresis, (B_{HYS})	B _{OPX} - B _{RPX}		45		Gauss

Typical application circuit





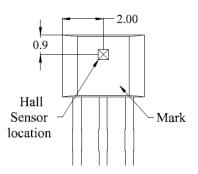
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Sensor Location, Package Dimension and Marking

UA Package

4.10 3.90 278 3.10 0.557 XXX 2.90 0.457 0.56 0.42 0.56 14.5 0.38 0.51 1.27 0.36

Hall Chip location



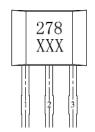
NOTES:

- 1. Controlling dimension: mm
- 2. Leads must be free of flash and plating voids
- 3. Do not bend leads within 1 mm of lead to package interface.
- 4. PINOUT:

Pin 1 VDD Pin 2 GND Pin 3 Output

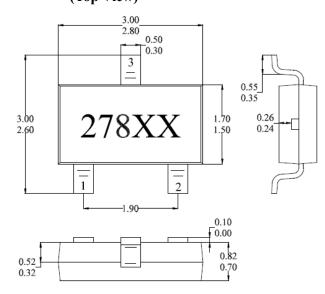
Output Pin Assignment





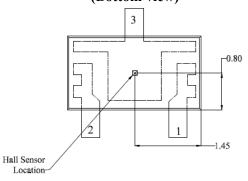
Package (SOT-23)

(Top View)

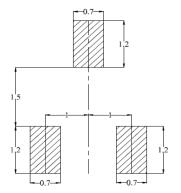


Hall Plate Chip Location

(Bottom view)



(For reference only)Land Pattern



NOTES:

- 1. PINOUT (See Top View at left :)
 Pin 1 V_{DD}; Pin 2 Output; Pin 3 GND
- 2. Controlling dimension: mm
- 3. Lead thickness after solder plating will be 0.254mm maximum